

用于信号线的 8 通道 ESD/EMI 保护芯片

UM8511 DFN16 3.3×1.3

描述

UM8511 是一款集成了 TVS 二极管的 (L-C) 低通滤波器阵列。该器件专为抑制便携式电子设备中的不需要的电磁干扰 (EMI) 信号并提供静电放电 (ESD) 保护而设计。该器件采用固态硅雪崩技术，具有卓越的箝位性能和直流电气特性。经过优化，该器件可用于保护手机和其他便携式电子产品中的信号线。

该器件由 8 路相同电路组成，包括用于 ESD 保护的 TVS 二极管，以及用于 EMI 滤波的 C-L-C 网络电路组成。采用典型的 17nH 电感值和 12pF 电容值组合，可在 800MHz 至 2.7GHz 范围内实现 19dB 的最小衰减。TVS 二极管可有效抑制超过 $\pm 15\text{kV}$ （空气间隙放电）和 $\pm 8\text{kV}$ （接触放电）的 ESD 电压，符合 IEC 61000-4-2 标准的第 4 级要求。

UM8511 采用符合 RoHS 规范的 DFN16 3.3×1.3 封装。引脚采用无铅工艺处理。该小型封装使其非常适合用于手机、数码相机和 PDA 等便携式电子产品。

应用

- 信号线保护
- 手机 CCD 摄像机线路
- 翻盖手机

特性

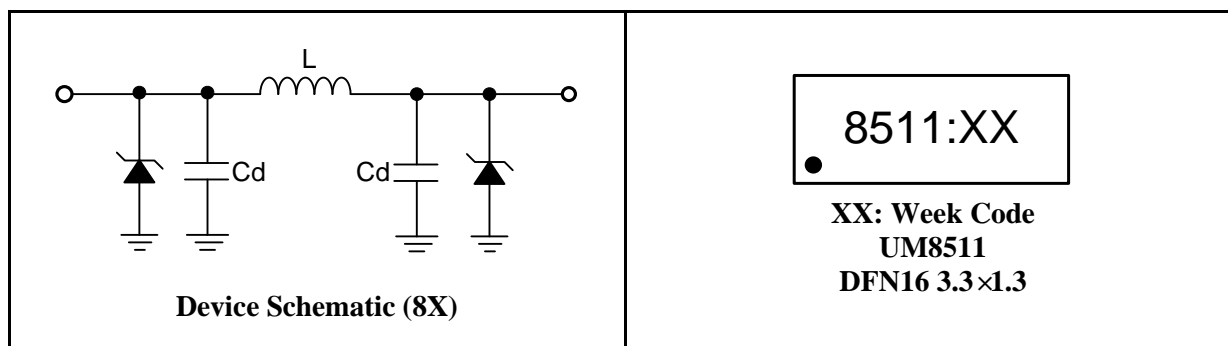
- 集成 TVS 的双向 EMI 滤波器，提供静电放电 (ESD) 保护
 - ESD 保护符合 IEC 61000-4-2 第 4 级要求： $\pm 15\text{kV}$ （空气间隙放电）， $\pm 8\text{kV}$ （接触放电）
 - 滤波性能：从 800MHz 到 2.7GHz 的最小衰减为 19 dB
 - TVS 工作电压：5V
 - 电感：17nH (典型值)
 - 电容：12pF (典型值，在 $V_R=2.5\text{V}$ 时)
 - 多路保护和滤波
- UM8511: 8 路

订购信息

芯片型号	工作电压	封装类型	通道数	丝印编码	发货数量
UM8511	5.0V	DFN16 3.3×1.3	8	8511	3000pcs /7Inch Tape & Reel

Pin Configurations

Top View



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Junction Temperature	T_J	125	°C
Operating Temperature Range	T_{OP}	-40 to 85	°C
Storage Temperature Range	T_{STG}	-55 to 150	°C

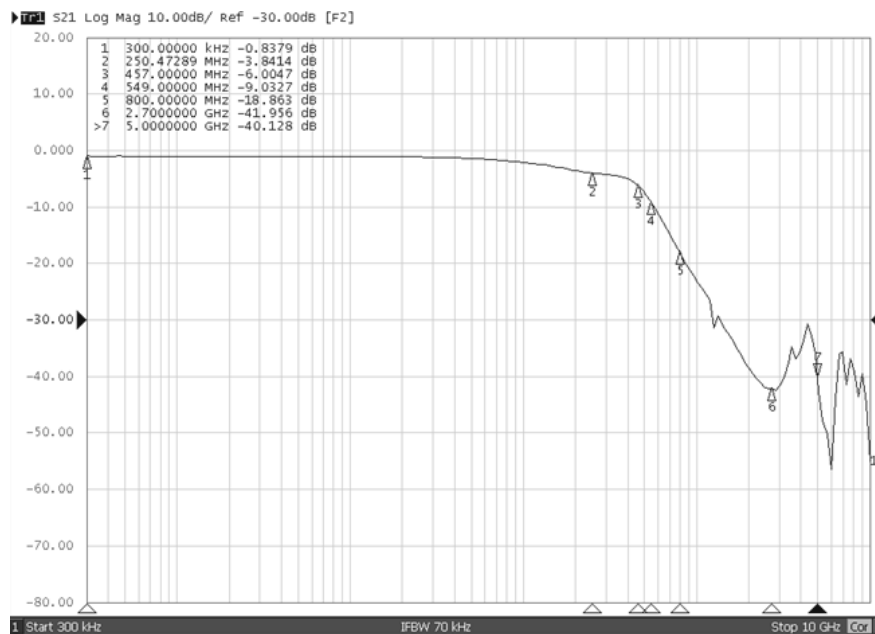
Electrical Characteristics

($T_J = 25\text{ °C}$, unless otherwise noted)

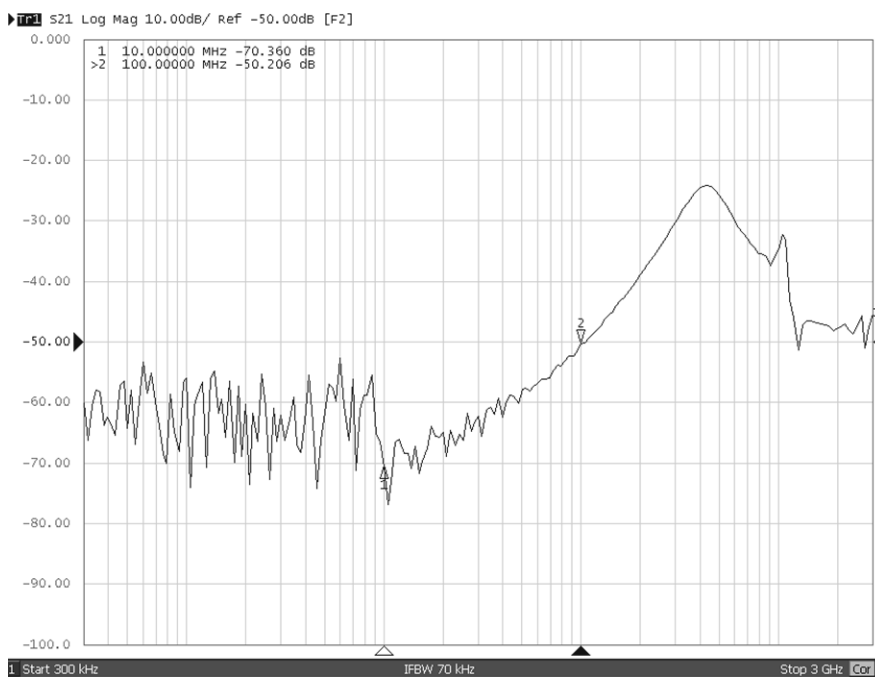
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
TVS Reverse Stand-Off Voltage	V_{RWM}				5	V
TVS Reverse Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	6	8	10	V
TVS Reverse Leakage Current	I_R	$V_{RWM} = 3.3\text{V}$			0.1	μA
DC Resistance	R_{cc}			10		Ω
Filter Cut-Off Frequency	f_c	$Z_{source} = Z_{load} = 50\Omega$		250		MHZ
Inductance	L			17		nH
Capacitance	C_d	$V_R = 2.5\text{V}$, $f = 1\text{MHz}$		12		pF
Total Capacitance	C_{total}	Input to GND, Each Line $V_R = 2.5\text{V}$, $f = 1\text{MHz}$	19	24	29	pF
Stop Band Attenuation		800MHz to 2.7GHz		19		dB

Typical Operating Characteristics

Typical Insertion Loss



Analog Crosstalk



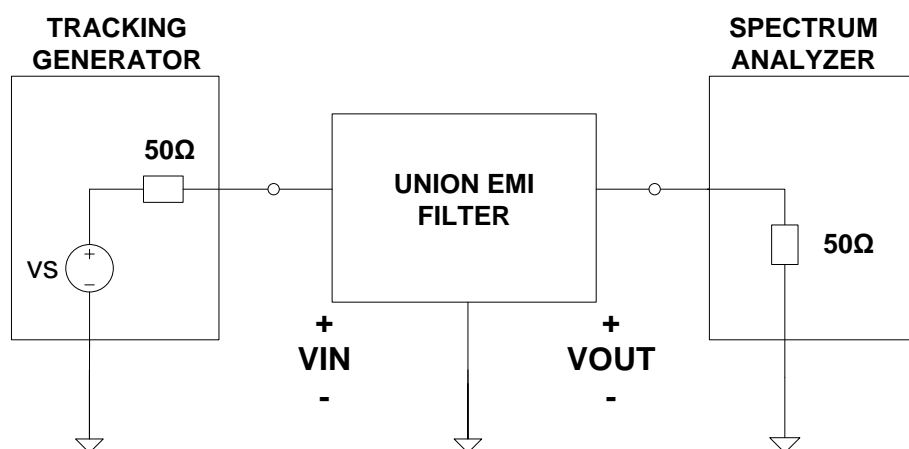
Applications Information

Insertion Loss

Insertion Loss (IL) is used to describe the transmission coefficient between two points in a circuit often described in terms of dB. When examining S parameters, S21 is often described as insertion loss. Insertion Loss and S21 will be used interchangeably from here on out. The insertion loss of a circuit with VOUT and VIN would be expressed as

$$IL=S_{21}(dB)=20\log(V_{OUT}/V_{IN})$$

The setup for measuring insertion loss in a 50Ω system is shown in Figure 1. It will be analyzed in a 50Ω environment, so the source impedance and load impedance is 50Ω. The transfer functions then can be analyzed in terms of insertion loss (S21).



**Figure 1. Test Conditions: Source Impedance=50Ω
Load Impedance=50Ω
Input Power=0dBm**

Cut Off Frequency

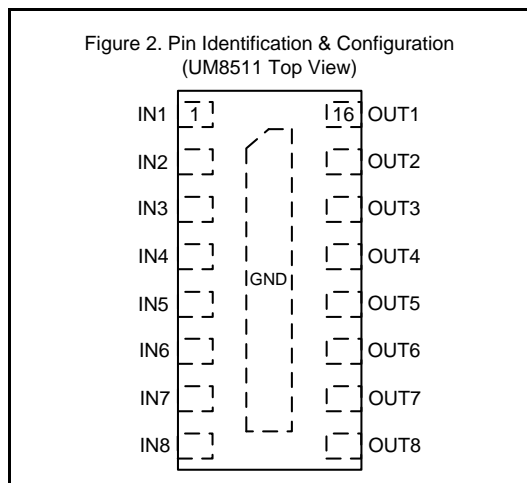
Cut off frequency is the frequency at which the signal strength is 3.0dB less than that of its Pass Band, 3.0dB of attenuation equates to half the original signal power. The Pass Band is the range of frequencies that are allowed to “pass” through a filter with minimal attenuation. For our purposes it starts from DC and ends at the cut off frequency.

Device Connection

The UM8511 is comprised of identical circuits each consisting of a low pass filter for EMI suppression and dual TVS diodes for ESD protection. The device is in a 16-pin DFN package. Electrical connection is made to all the pins located at the bottom of the device. A center tab serves as the ground connection. The device has a flow through design for easy layout. All path lengths should be kept as short as possible to minimize the effects of parasitic inductance in the board traces.

Ground Connection Recommendation

Parasitic inductance (L) present in the board layout will affect the filtering performance of the device. As frequency (f) increases, the effect of the inductance becomes more dominant. This effect is given by Equation 1.



Pin	Identification
1-8	Input Lines
9-16	Output Lines
Center Tab	Ground

Equation 1: The Impedance of an Inductor at Frequency XLF

$$X_{LF}(L, f) = 2 \times \pi \times f \times L$$

Where:

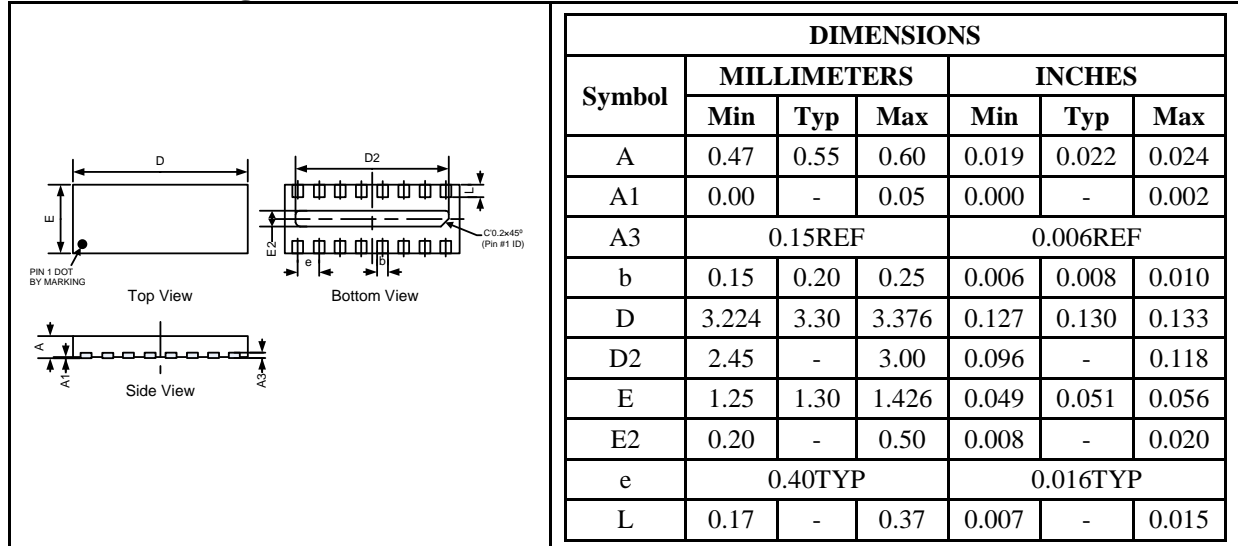
L= parasitic inductance in the PCB (H)

f = frequency (Hz)

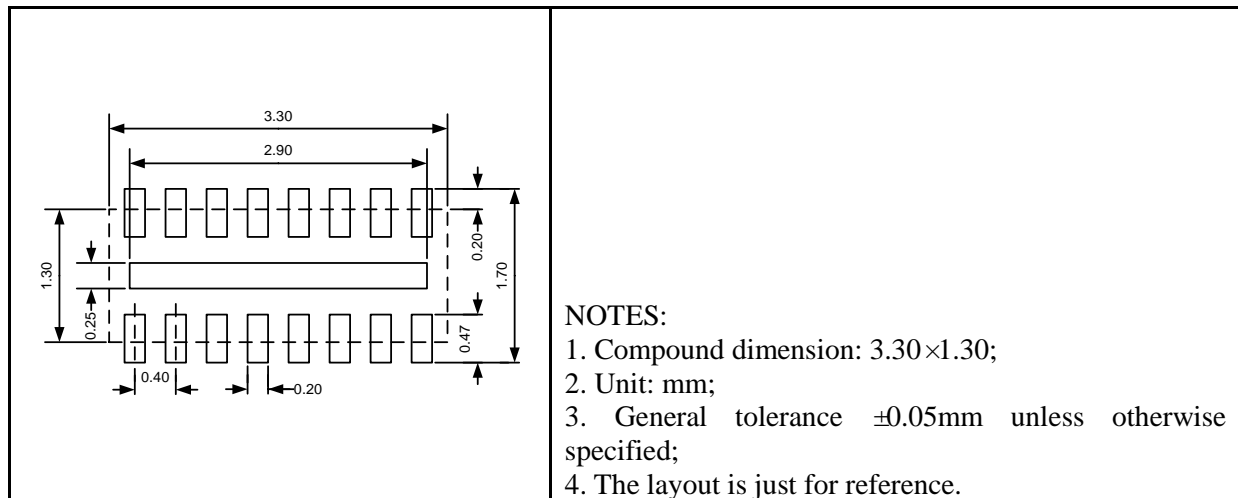
Package Information

UM8511: DFN16 3.3×1.3

Outline Drawing



Land Pattern



Tape and Reel Orientation



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